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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of )

RICHARD R. HENGST )

on APPARATUS AND METHOD OF )  
MAKING A SLIP FREE WAFER BOAT )

Serial No.: 09/884,720 )

Filed on: June 19, 2001 )

Group Art Unit: 2825  
Exmr.: Unknown

(Our Docket No. 6096-01)

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LETTER TO THE OFFICIAL DRAFTSMAN

Dear Sirs:

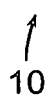
Applicant hereby submits five (5) sheets (Figs. 1-5) of formal drawings to replace the informal drawings forming part of the application as on file.

Respectfully submitted,

By

*Stephen P. Scuderi*  
Stephen P. Scuderi  
Registration No. 42,136  
Attorney for Applicants

MCCORMICK, PAULDING & HUBER LLP  
CityPlace II, 185 Asylum Street  
Hartford, CT 06103-4102  
Tel: (860) 549-5290



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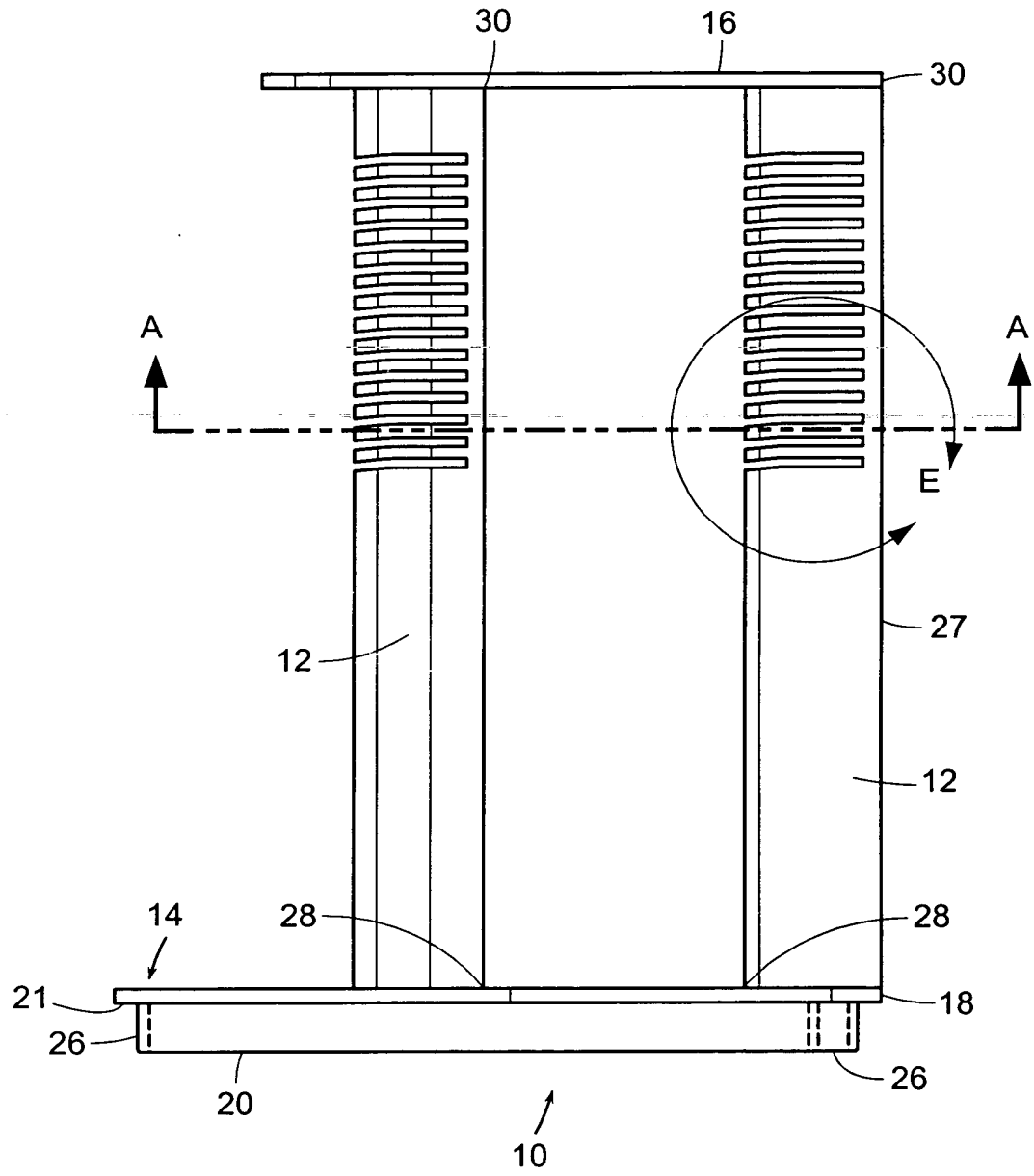


FIG. 2

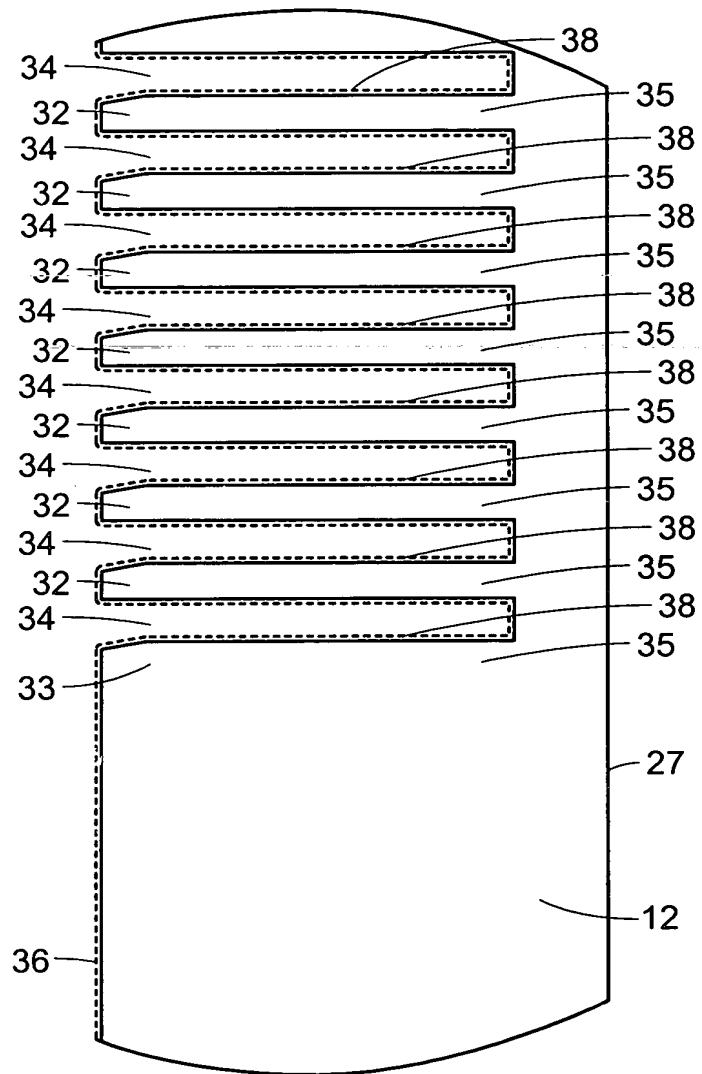


FIG. 3

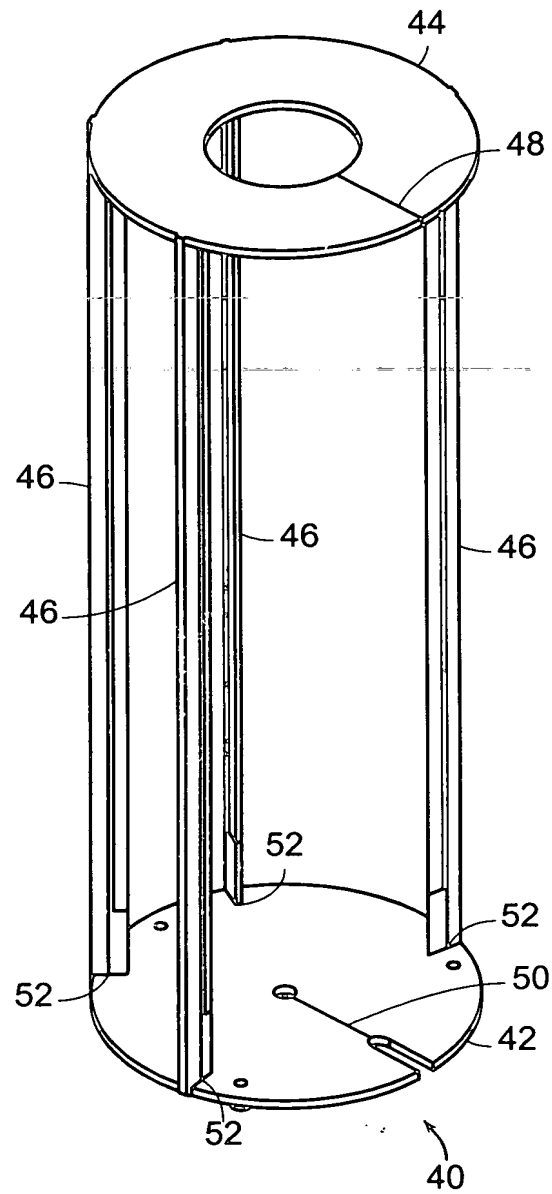


FIG. 4

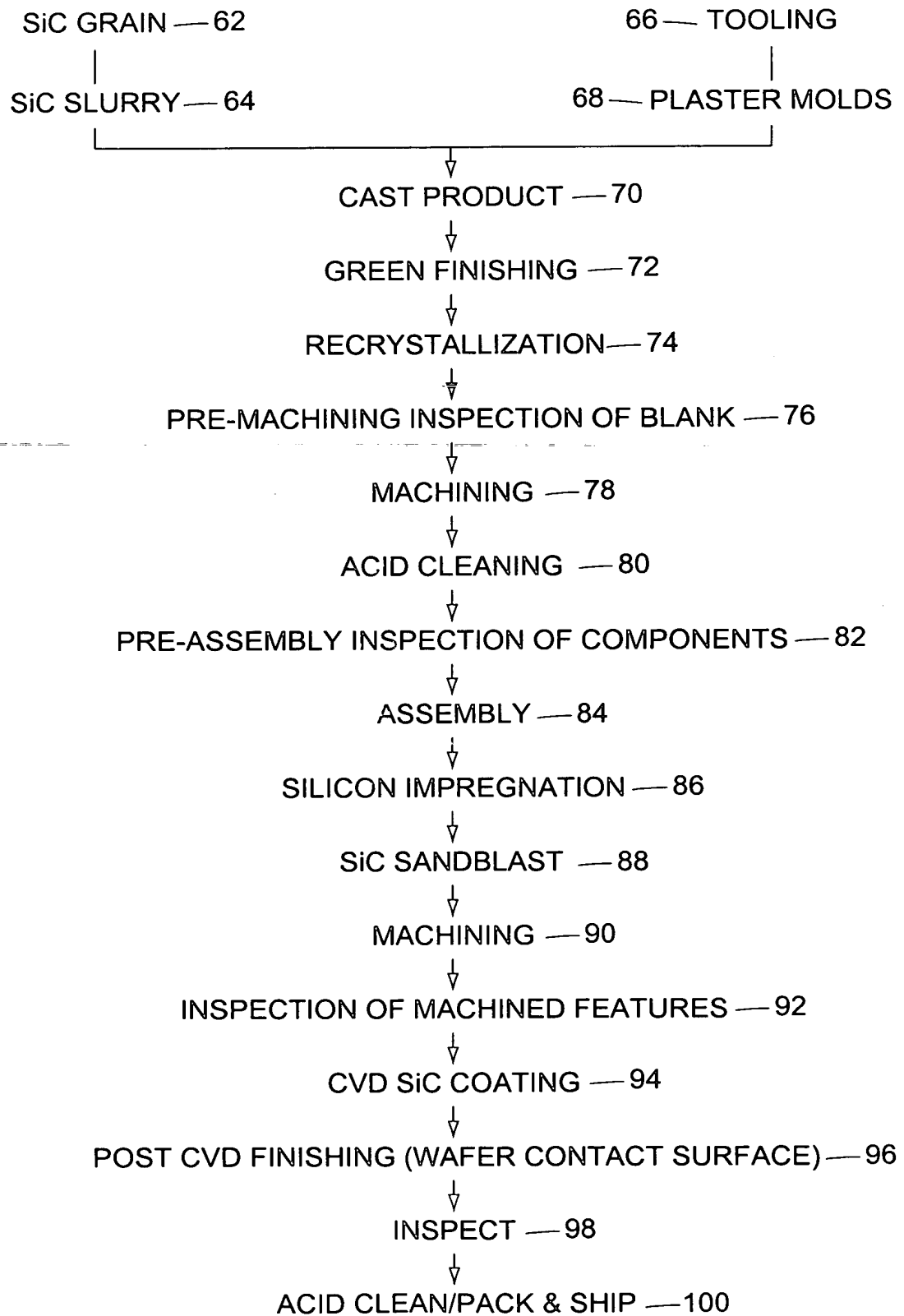


FIG. 5